



VMDSEMI

**VUSB002R240NB**

**Datasheet**

## General Description

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
20V	24mΩ@4.5V	5A
	32mΩ@2.5V	
	42mΩ@1.8V	

## Symbol

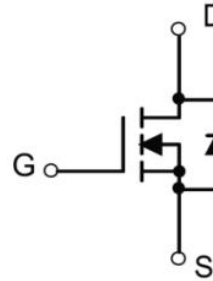


Figure 1 Symbol of VUSB002R240NB

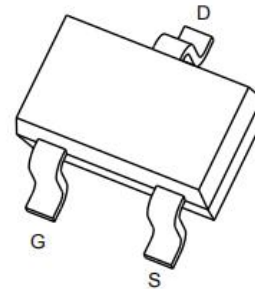
## Features

- Excellent  $R_{DS(on)}$  and Low Gate Charge
- Trench Technology Power MOSFET

## Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

## Package Type



### SOT-23

Figure 2 Package Type of VUSB002R240NB

## Ordering Information

Product Name	Package
VUSB002R240NB	SOT-23

**Absolute Maximum Ratings** ( $T_A = 25\text{ °C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	±8	V
Continuous Drain Current <sup>Note1,5</sup>	$I_D$	5	A
Pulsed Drain Current <sup>Note2</sup>	$I_{DM}$	20	A
Total Power Dissipation <sup>Note4,5</sup>	$P_D$	1.5	W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note5</sup>	$R_{\theta JA}$		83.3		°C/W

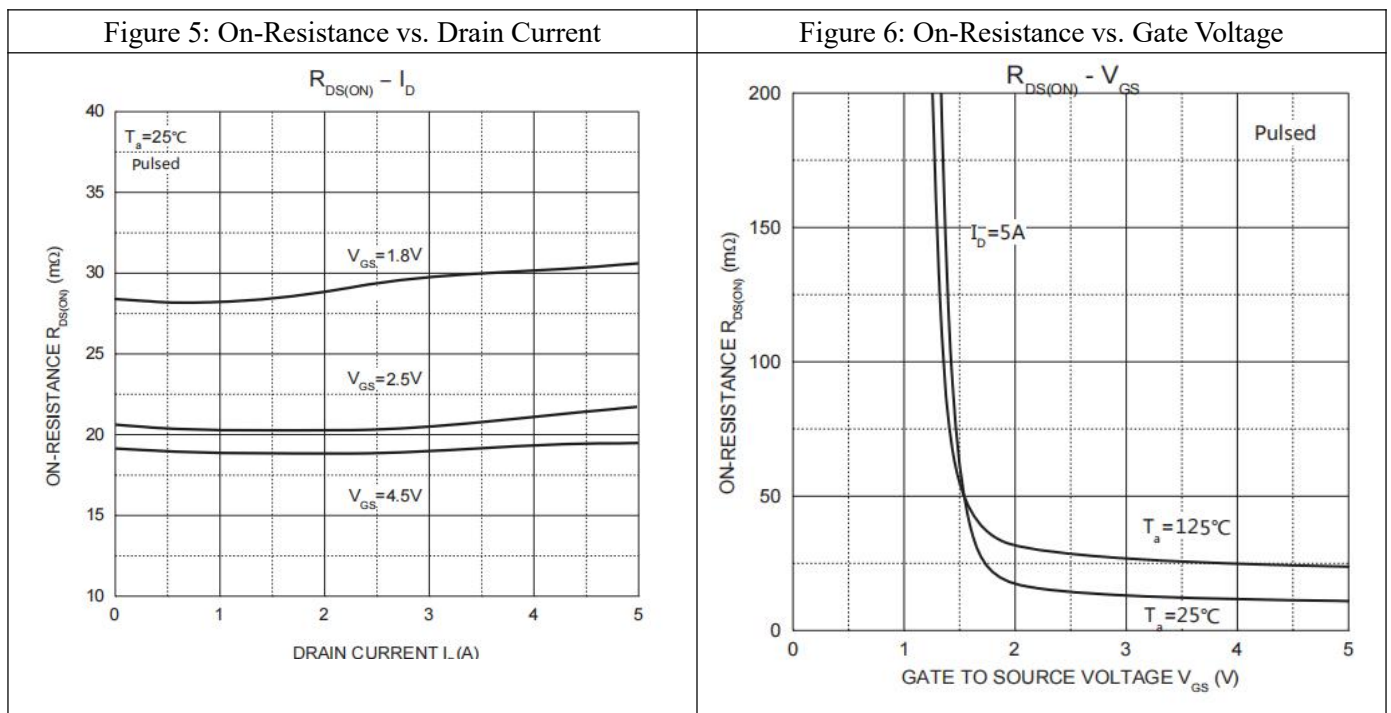
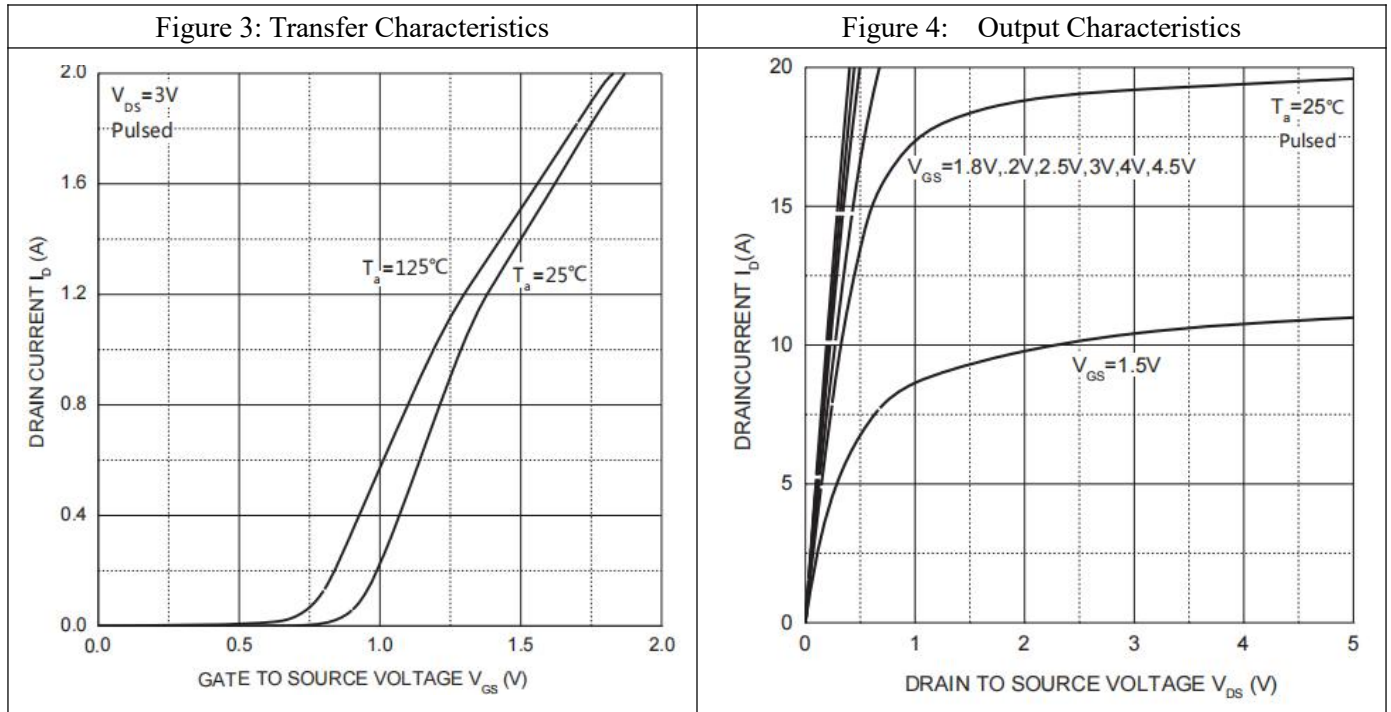
**Electrical Characteristics** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

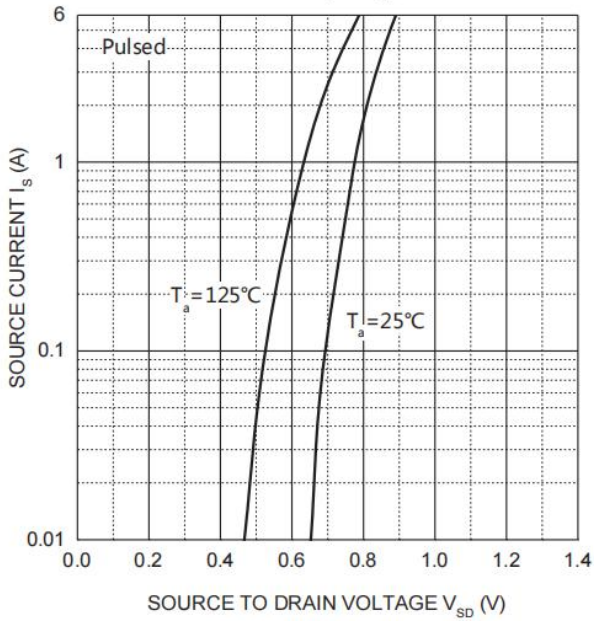
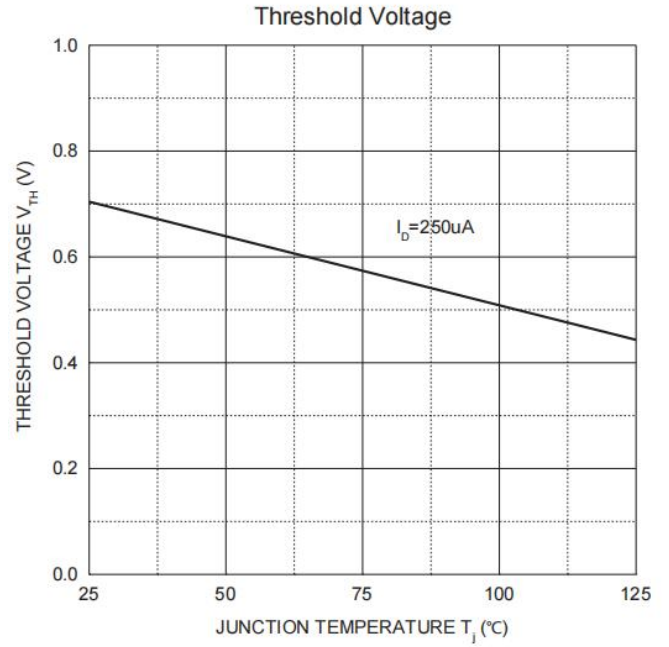
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 8V, V_{DS}=0V$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.45	0.7	1.0	V
Static Drain-Source On-Resistance <sup>Note3</sup>	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=5A$		17	24	mΩ
		$V_{GS}=2.5V, I_D=4.7A$		20	32	
		$V_{GS}=1.8V, I_D=4.3A$		30	42	
Forward tranconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=10V, I_D=5A$	6			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=10V$		901		pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$		110		pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$		58		pF
Gate resistance	$R_g$	$f=1MHz, \text{Open drain}$	0.5		4.8	Ω
<b>Switching Parameters</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V$		11		ns
Turn-on Rise Time	$t_r$	$V_{GEN}=5V$		19		
Turn-off Delay Time	$t_{d(off)}$	$R_L=2.2\Omega$		33		
Turn-off Fall Time	$t_f$	$R_G=1\Omega, I_D=4A$		11		
<b>Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$V_{DS}$	$V_{GS}=0V, I_S=4A$		0.7	1.2	V

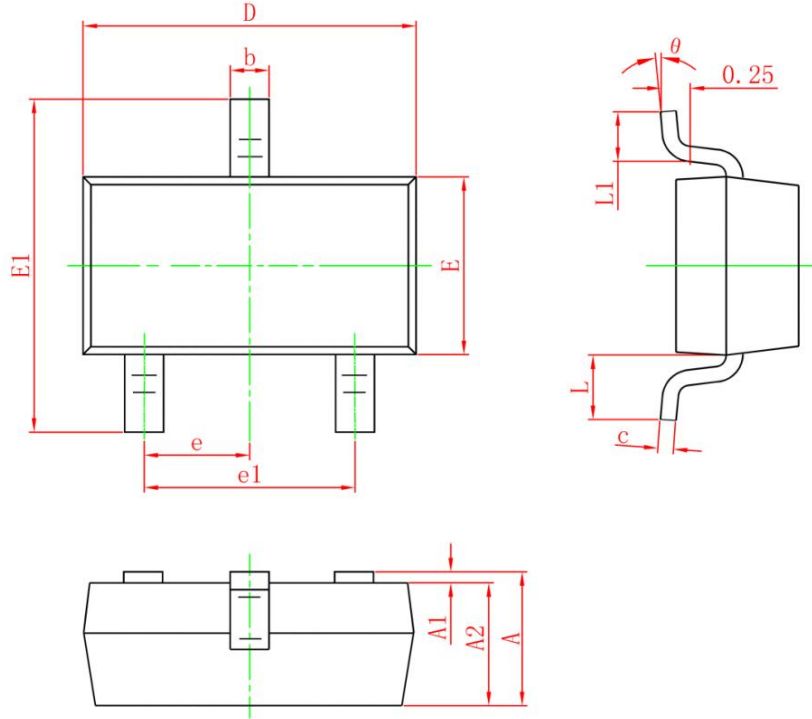
Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ\text{C}$ .
- 5.Device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Performance Characteristics



**Figure 7: Body Diode Characteristics**

**Figure 8: Threshold Voltage**


**Mechanical Dimensions:**
**SOT-23 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0	0.100	0	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.150	1.500	0.045	0.059
E1	2.250	2.650	0.089	0.104
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
$\theta$	0°	8°	0°	8°

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